

TECHNICAL DATA SHEET 2 / 5					
STRAIGHT MALE RECEPTACLE SMT			R222.941.100		
FULL DETENT-TAPE AND REEL BY 500			Series : SMP-COM		
PACKAGING Standard Unit Other 500 Contact us		SPECIFICATION			
ELECTRICAL CHARACTERISTICS		<u>ENVIRONMENTAL</u>			
requency 0-12.4* GHz Herm		Operating temper Hermetic seal Panel leakage	rature -55/+125 ° C NA Atm.cm3/s NA		
Dielectric withstanding voltage 500	Veff mini $M\Omega$ mini	OTHER CHARACTERISTICS			
		Assembly instruc Others :			
MECHANICAL CHARACTERISTICS		* ROS 1.35 at 12.4GHz **ROS at 6GHz			
Axial force – Opposite end 6.8	N mini N mini N.cm mini				
	N.cm N.cm				
Mating life 100 Weight 0,3350	Cycles mini g				
Issue : 1121 C In the effort to improve our products, we reserve necessary.	e the right to make cha	anges judged to be			

TECHNICAL DATA SHEET

STRAIGHT MALE RECEPTACLE SMT

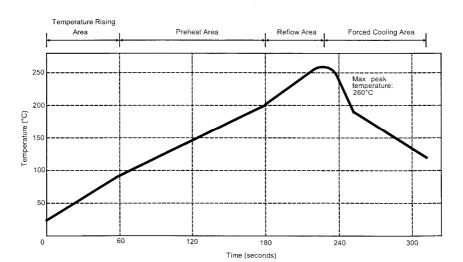
FULL DETENT-TAPE AND REEL BY 500

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SOLDER PROCEDURE

- Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component . Adhesive agents must not be used on the receptacle.
- **3.** This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.



TEMPERATURE PROFILE

Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec



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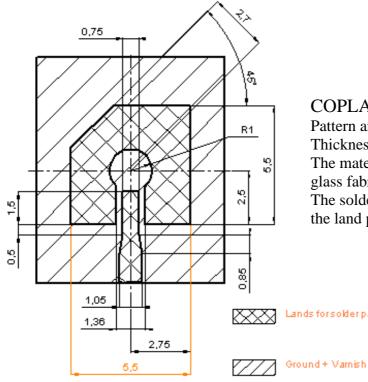
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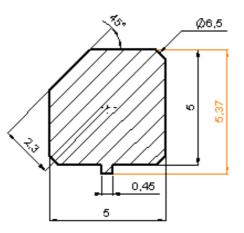


COPLANAR LINE

Pattern and signal are on the same side. Thickness of PCB : 1.6mm The material of PCB is the epoxy resin of glass fabrics bacs (ER:4.8). The solder resist should be printed exept for the land pattern on the PCB.

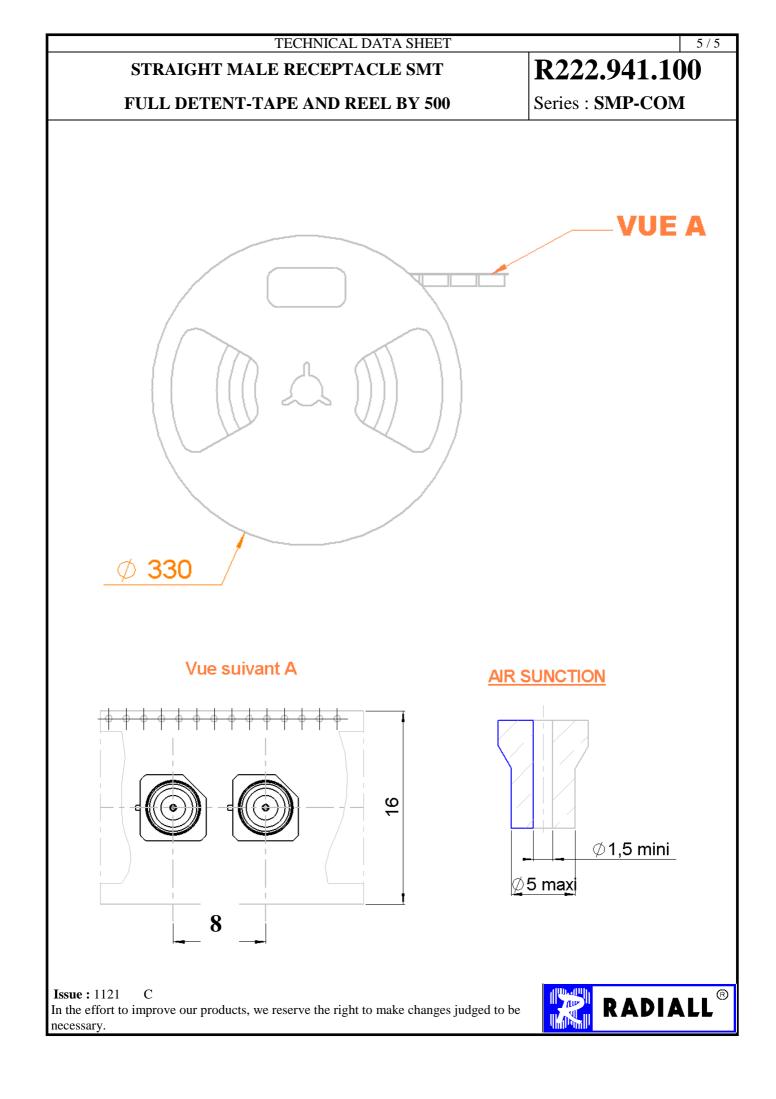
Lands for solder paste

SHADOW OF RECEPTACLE FOR VIDEO CAMERA



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